



**TET ESTEL AS
ESTONIA**

**April
2016**

**Series
TFI243-630**

High Frequency Inverter grade Capsule Thyristor Type TFI243-630

Low switching losses

Low reverse recovery charge

Distributed amplified gate for high di/dt

Maximum mean on-state current	ITAV	630 A							
Maximum repetitive peak off-state and reverse voltage	UDRM, URRM	800 ÷ 1500 V							
Turn-off time	tq	16; 20; 25 µs							
UDRM, URRM, V	800	900	1000	1100	1200	1300	1400	1500	
Voltage code	8	9	10	11	12	13	14	15	
Tvj, °C	- 60 ÷ 125								

MAXIMUM ALLOWABLE RATINGS				
Symbols and parameters		Units	TFI243-630	Conditions
ITAV	Mean on-state current	A	630 890	Tc=80 °C, Tc=55 °C, 180° half-sine wave, 50 Hz
ITRMS	RMS on-state current	A	989	Tc=80 °C
ITSM	Surge on-state current	kA	11,0 12,0	Tvj=125°C Tvj=25°C
I ² t	Limiting load integral	kA ² s	605 720	Tvj=125°C Tvj=25°C
UDRM, URRM	Repetitive peak off-state and reverse voltage	V	800÷1500	Tj min≤Tvj≤Tjm 180° half-sine wave, 50 Hz Gate open
UDSM, URSM	Non-repetitive peak off-state and reverse voltage	V	880÷1600	Tj min≤Tvj≤Tjm 180° half-sine wave tp=10 ms, Single pulse Gate open
(di/t/dt) crit	Critical rate of rise of on-state current : non - repetitive repetitive	A/µs	2000 1250	Tvj=125°C ; Ud=0,67 UDRM, Gate pulse : 10V, 5 Ω, 1µs rise time, 10 µs
URGM	Peak reverse gate voltage	V	5	Tj min≤Tvj≤Tjm
Tstg	Storage temperature	°C	-60÷80	
Tvj	Junction temperature	°C	-60÷125	

CHARACTERISTICS

UTM	Peak on-state voltage	V	2,5	Tvj=25°C, ITM=3,14 ITAV
UT(TO)	Threshold voltage	V	1,4	Tvj=125°C
R _T	On-state slope resistance	mΩ	0,46	1,57 ITAV < It < 4,71 ITAV
IDRM IRRM	Repetitive peak off-state and reverse current	mA	50 50	Tvj=125°C, UD = UDRM UR = URRM

CHARACTERISTICS							
Symbols and parameters		Units	TFI243-630		Conditions		
I _L	Latching current		A	7	Tvj=25°C, UD=12V Gate pulse : 10V, 5Ω, 1 μs rise time, 10μs		
I _H	Holding current		A	0,5	Tvj=25°C, UD=12V, Gate open		
UGT	Gate trigger direct voltage		V	2,5 5,0	Tvj=25°C, Tvj=-60°C	UD=12V	
IGT	Gate trigger direct current		A	0,3 0,85	Tvj=25°C, Tvj=-60°C		
UGD	Gate non-trigger direct voltage		V	0,25	Tvj=125°C, UD = 0,67 U _{DRM} Direct gate current		
IGD	Gate non-trigger direct current		mA	10			
t _{gd}	Delay time		μs	1,6	Tvj=25°C, UD=500V ITM = 630 A Gate pulse : 10V, 5Ω, 1 μs rise time, 10μs		
t _{gt}	Turn-on time		μs	2,5			
t _q	Turn-off time		μs	16÷25 20÷32	Tvj=125°C, ITM =630 A di _R /dt =10 A/μs, UR=100V UD = 0,67 U _{DRM} du _D /dt=50 V/μs du _D /dt=200 V/μs		
Qrr	Recovered charge		μC	210	Tvj=125°C, ITM =630 A dir/dt =50 A/μs, UR=100V		
trr	Reverse recovery time		μs	3,5			
Irrm	Peak reverse recovery current		A	120			
(dud/dt)crit	Critical rate of rise of off-state voltage		V/μs	500 1000	Tvj=125°C, UD = 0,67 U _{DRM} Gate open		
R _{thjc}	Thermal resistance junction to case		°C/W	0,032	Direct current, double side cooled		

ORDERING								
	TFI	243	630	14	7	7	3	
	1	2	3	4	5	6	7	

1. Fast thyristor with interdigitated gate structure.
2. Design version.
3. Mean on-state current, A.
4. Voltage code (14=1400 V).
5. Critical rate of rise of off-state voltage (6 ≥ 500 V/μs, 7 ≥ 1000 V/μs).
6. Group of turn-off time (du_D/dt=50 V/μs, 5 ≤ 25 μs, 6 ≤ 20 μs, 7 ≤ 16 μs).
7. Group of turn-on time (3 ≤ 2,5μs).

